# 21A 11-19-01

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s):

T. UCHIDA, et al.

170 1

Serial No.:

Not Yet Assigned

(Continuation Application of SN 09/763,891

Filed: February 28, 2001)

Filed:

October 15, 2001

For:

ABRASIVE LIQUID FOR METAL AND METHOD

OF POLISHING

## PRELIMINARY AMENDMENT

Assistant Commissioner of Patents

October 15, 2001

Washington, D.C. 20231

Sir:

Please amend the above-identified application, prior to examination thereof, as follows:

## **IN THE SPECIFICATION:**

Page 1, between the title and the heading "Technical Field", please add the following new paragraph:

This application is a Continuation application of application Serial No.

09/763,891, filed February 28, 2001, which is a National Stage application filed under 35 USC §371 of International (PCT) Application No. PCT/JP99/04694,

filed August 31, 1999. [--.